

1746 IGV

## IE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: Tsuga et al.

Docket No.: TI-31619

Serial No.: 10/072,073

Art Unit: 1746

Filed: 02/08/02

Examiner: Kornakov, M.

Title: Method for Removing Particles on Semiconductor Wafers

## **AMENDMENT UNDER 37 CFR 1.111**

May 18, 2004

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Karen Vertz 5-18-04
Karen Vertz Date

In response to the Office Action, dated 02/25/2004, in the above-identified patent application, please make the following amendments. They are respectfully submitted as a full and complete response to that Action. Charge any required fees to the deposit account of Texas Instruments Incorporated, Account No. 20-0668.